

1104780

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Complete housing for Raspberry Pi printed-circuit boards. Includes housing half shells, adhesive strips for integrating the display, side panels with openings for all relevant connections, adhesive pads for affixing the Raspberry Pi model B2 and B3 computers, screws for housing and PCB attachment; light gray housing with turquoise-blue corner inlays

Your advantages

- Glue & play ready-to-install solution with no further processing
- · Space for additional electronics expands the Raspberry Pi minicomputer's areas of application
- · Can be used universally thanks to extensive accessories

Commercial data

Item number	1104780
Packing unit	1 pc
Minimum order quantity	1 pc
Sales key	AC03
Product key	ACFCAA
GTIN	4055626972381
Weight per piece (including packing)	678.1 g
Weight per piece (excluding packing)	669.7 g
Customs tariff number	84879090
Country of origin	DE



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Technical data

Notes

General	The housing can be opened a maximum of 10 times.
General	Attach the adhesive pads: Make sure that the surface of the housing is clean, dry, and free of grease. Temperature range: +18°C +30°C / Closing pressure force: 60 N / Closing pressure time: 3 s

Product properties

Product type	Complete housing
Housing series	UCS
Product family	UCS 237-195-F
Туре	Flat design (GD), RPI-DT7
Housing type	Universal housings
Ventilation openings present	no

Dimensions

Dimensional drawing	w h
Width	237 mm
Height	195 mm
Depth	47 mm
Dimensions	212 mm x 170.2 mm (Maximum circuit board dimensions)
PCB design	
PCB thickness	0.8 mm 3 mm

Material specifications

Color (Housing)	light grey (RAL 7035)
Flammability rating according to UL 94	V0
CTI according to IEC 60112	225
Insulating material	PC
Surface characteristics	untreated
Housing material	PC

Environmental and real-life conditions

Power dissipation single housing for 20 °C

Ambient temperature	20 °C
Reduction factor	1
Mounting position	vertical



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Power dissipation	31 W
Power dissipation single housing for 30 °C	
Ambient temperature	30 °C
Reduction factor	0.8
Mounting position	vertical
Power dissipation	25.5 W
Power dissipation single housing for 40 °C	
Ambient temperature	40 °C
Reduction factor	0.65
Mounting position	vertical
Power dissipation	20.3 W
Power dissipation single housing for 50 °C	
Ambient temperature	50 °C
Reduction factor	0.5
Mounting position	vertical
Power dissipation	15.5 W
Power dissination single housing for 60 °C	
Power dissipation single housing for 60 °C Ambient temperature	60 °C
Reduction factor	0.32
Mounting position	vertical
Power dissipation	10 W
1 Over dissipation	10 **
Vibration test	
Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.15 mm (10 Hz 58.1 Hz)
Acceleration	2g (58.1 Hz 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis
Glow-wire test	
Specification	IEC 60695-2-11:2014-02
Temperature	850 °C
Time of exposure	30 s
Thermal stability / ball thrust test	
Specification	IEC 60695-10-2:2014-02
Temperature	125 °C
Test duration	1 h
Force	20 N
Mechanical strength / tumbling barrel	
Specification	IEC 60068-2-31:2008-05



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Height of fall	50 cm
Frequency	50
hocks Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	15g
Shock duration	11 ms
	3
Number of shocks per direction Test directions	X-, Y- and Z-axis (pos. and neg.)
rest directions	A-, 1- and 2-axis (pos. and neg.)
est for substances that would hinder coating with paint o	r varnish
Specification	VW PV 3.10.7:2005-02
Result	Test passed
egree of protection (IP code)	
Specification	IEC 60529:1989-11 + AMD 1:1999-11 + AMD 2:2013-08
Result, degree of protection, IP code	IP20
mbient conditions	
Max. IP code to attain	IP20
Ambient temperature (operation)	-20 °C 70 °C (depending on power dissipation)
Ambient temperature (storage/transport)	-30 °C 55 °C
Ambient temperature (assembly)	-5 °C 100 °C
Relative humidity (storage/transport)	80 %
Troidavo Harmany (crorago, narroporty	66 %
B data	
Number of PCB holders	1
Type of PCB mount	Bolt mounting
Total PCB surface	36040 mm²
Thickness of the PCB	0.8 mm 3 mm
Supported form factors	Raspberry Pi
Note on PCB holders	This product is prepared for a printed-circuit board. Additional printed-circuit boards can be mounted using adhesive pads (accessories).
unting	
Mounting type	Screw mounting
Mounting position	any
Tightening torque / speed	Screw connection between housing halves: 1.2 Nm-1.4 Nm / 5 rpm-1000 rpm
	Mounting the PCB: 0.4 Nm-0.5 Nm / 500 rpm-1000 rpm
ckaging specifications	
Type of packaging	Roy nackaging
Type of packaging	Box packaging



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Classifications

ECLASS

	ECLASS-11.0	27182702	
	ECLASS-13.0	27190603	
ΕΊ	ТІМ		
	ETIM 9.0	EC001031	
UNSPSC			
	UNSPSC 21.0	31261500	

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